

L Number	Hits	Search Text	DB	Time stamp
-	2	(chia-pin with lin).in.	USPAT;	2003/05/23
-	126381	circuit adj board	US-PGPUB	13:55
-	1411	isolating adj layer	USPAT;	2003/05/16
-	78	(circuit adj board) and (isolating adj layer)	US-PGPUB	14:21
-	12002	copper adj foil	USPAT;	2003/05/16
-	2588	(circuit adj board) same (copper adj foil)	US-PGPUB	14:20
-	340	polyimide same ((circuit adj board) same (copper adj foil))	USPAT;	2003/05/02
-	8071	polyimide with coating	US-PGPUB	09:50
-	17	(polyimide with coating) same ((circuit adj board) same (copper adj foil))	USPAT;	2003/05/02
-	80494	156/\$.ccls.	US-PGPUB	09:50
-	593	2.ab,ti. and 156/\$.ccls.	USPAT;	2003/05/02
-	206	(copper adj foil) and (2.ab,ti. and 156/\$.ccls.)	US-PGPUB	09:51
-	1373	coat\$3 with isolating	USPAT;	2003/05/02
-	29	2.ab,ti. and (coat\$3 with isolating)	US-PGPUB	09:52
-	2244	FR-4 or FR-5	USPAT;	2003/05/02
-	3762	coat\$3 same (copper adj foil)	US-PGPUB	09:57
-	200	(FR-4 or FR-5) and (coat\$3 same (copper adj foil))	USPAT;	2003/05/02
-	72	substrate same (adhesive with coating) same (copper adj foil)	US-PGPUB	12:02
-	6481	epoxy with glass with substrate	USPAT;	2003/05/02
-	1344	(copper adj foil) and (epoxy with glass with substrate)	US-PGPUB	12:02
-	821	coating and ((copper adj foil) and (epoxy with glass with substrate))	USPAT;	2003/05/02
-	590	(copper adj foil) same (epoxy with glass with substrate)	US-PGPUB	12:07
-	46	coating same ((copper adj foil) same (epoxy with glass with substrate))	USPAT;	2003/05/02
-	69	(circuit adj board) and 156/307.7.ccls.	US-PGPUB	12:07
-	2	5435877.URPN.	USPAT;	2003/05/02
			US-PGPUB	13:22
			USPAT;	2003/05/02
			US-PGPUB	13:23
			USPAT;	2003/05/02
			US-PGPUB	13:23
			USPAT;	2003/05/02
			US-PGPUB	13:39
			USPAT;	15:04
			USPAT	2003/05/02
				14:31

-	2000	(copper adj clad) with (laminat r laminated)	USPAT; US-PGPUB	2003/05/02 15:05
-	240	(r ll with oating) and ((opp r adj clad) with (laminat or laminat d))	USPAT; US-PGPUB	2003/05/02 15:06
-	1205	is lating adj mat rial	USPAT; US-PGPUB	2003/05/16 14:21
-	119	(circuit adj board) and (isolating adj material)	USPAT; US-PGPUB	2003/05/16 15:29
-	1743	(copper adj clad) with laminate	USPAT; US-PGPUB	2003/05/16 15:33
-	1	(isolating adj material) and ((copper adj clad) with laminate)	USPAT; US-PGPUB	2003/05/16 15:33
-	18	4696851.URPN.	USPAT	2003/05/16 16:32
-	549	156/307.7.ccls.	USPAT; US-PGPUB	2003/05/19 11:35
-	1	3726710.pn.	USPAT; US-PGPUB	2003/05/19 11:35
-	18382	coat\$3 with foil	USPAT; US-PGPUB	2003/05/23 13:56
-	127683	circuit adj board	USPAT; US-PGPUB	2003/05/23 13:57
-	2123	(coat\$3 with foil) and (circuit adj board)	USPAT; US-PGPUB	2003/05/23 13:57
-	4605	FR-4 or FR4 or FR-5 or FR5	USPAT; US-PGPUB	2003/06/03 15:28
-	224	(coat or coated or coating) same (resin or adhesive) same (FR-4 or FR4 or FR-5 or FR5)	USPAT; US-PGPUB	2003/06/03 15:39
-	121	copper same ((coat or coated or coating) same (resin or adhesive) same (FR-4 or FR4 or FR-5 or FR5))	USPAT; US-PGPUB	2003/06/03 15:41
-	30	(US-5234522-\$ or US-4311749-\$ or US-4400438-\$ or US-6379487-\$ or US-6273989-\$ or US-6376008-\$ or US-6130000-\$ or US-5806177-\$ or US-5837355-\$ or US-4752499-\$ or US-4696851-\$ or US-4401499-\$ or US-4302501-\$ or US-4087300-\$ or US-6403396-\$ or US-6236302-\$ or US-6172591-\$ or US-5435877-\$ or US-6335076-\$ or US-5672226-\$ or US-3936575-\$ or US-6405431-\$ or US-6107003-\$ or US-5830563-\$ or US-4308301-\$ or US-3956043-\$).did. or (US-20020126460-\$ or US-20030034125-\$ or US-20030087101-\$ or US-20020078561-\$).did.	USPAT; US-PGPUB	2003/06/09 11:53

-	15	polyimide and ((US-5234522-\$ r US-4311749-\$ or US-4400438-\$ or US-6379487-\$ r US-6273989-\$ r US-6376008-\$ r US-6130000-\$ or US-5806177-\$ or US-5837355-\$ or US-4752499-\$ or US-4696851-\$ or US-4401499-\$ or US-4302501-\$ or US-4087300-\$ or US-6403396-\$ or US-6236302-\$ or US-6172591-\$ or US-5435877-\$ or US-6335076-\$ or US-5672226-\$ or US-3936575-\$ or US-6405431-\$ or US-6107003-\$ or US-5830563-\$ or US-4308301-\$ or US-3956043-\$).did. or (US-20020126460-\$ or US-20030034125-\$ or US-20030087101-\$ or US-20020078561-\$).did.)	USPAT; US-P PUB	2003/06/09 12:33
-	47	(roll with coating) same prepreg	USPAT; US-PGPUB	2003/06/09 15:18
-	8	(high adj profile) with copper	USPAT; US-PGPUB	2003/06/09 15:20
-	113	(high adj profile) and (low adj profile) and copper	USPAT; US-PGPUB	2003/06/09 15:21
-	3	(reverse with copper) and ((high adj profile) and (low adj profile) and copper)	USPAT; US-PGPUB	2003/06/09 15:21